

# 74HC30DB,118 Datasheet



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DiGi Electronics Part Number 74HC30DB,118-DG

Manufacturer Nexperia USA Inc.

Manufacturer Product Number 74HC30DB,118

Description IC GATE NAND 1CH 8-INP 14SSOP

Detailed Description NAND Gate IC 1 Channel 14-SSOP



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# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
74HC30DB,118	Nexperia USA Inc.
Series:	Product Status:
74HC	Obsolete
Logic Type:	Number of Circuits:
NAND Gate	1
Number of Inputs:	Features:
8	
Voltage - Supply:	Current - Quiescent (Max):
2V ~ 6V	2 μΑ
Current - Output High, Low:	Input Logic Level - Low:
5.2mA, 5.2mA	0.5V ~ 1.8V
Input Logic Level - High:	Max Propagation Delay @ V, Max CL:
1.5V ~ 4.2V	22ns @ 6V, 50pF
Operating Temperature:	Mounting Type:
-40°C ~ 125°C	Surface Mount
Supplier Device Package:	Package / Case:
14-SSOP	14-SSOP (0.209", 5.30mm Width)
Base Product Number:	
74HC30	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):			
ROHS3 Compliant	1 (Unlimited)			
REACH Status:	ECCN:			
REACH Unaffected	EAR99			
HTSUS:				
8542.39.0001				

# 8-input NAND gate

Rev. 10 — 13 March 2024 Product data sheet

### 1. General description

The 74HC30; 74HCT30 is an 8-input NAND gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC30: CMOS level
  - For 74HCT30: TTL level
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

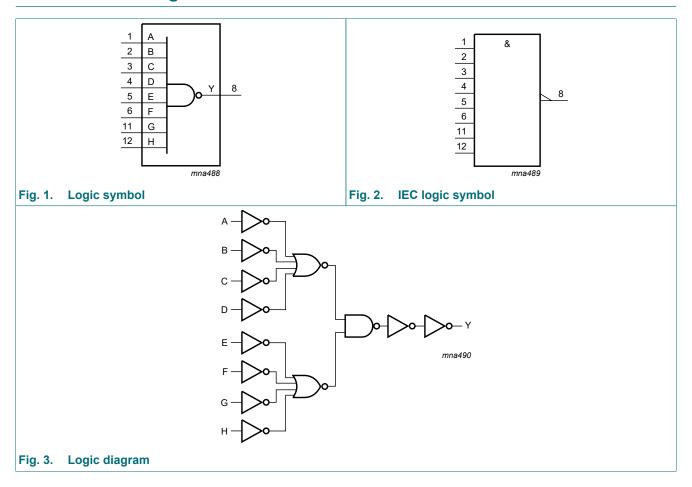
### 3. Ordering information

#### **Table 1. Ordering information**

Table 1. Gracing information												
Type number	Package Package											
	Temperature range	Name	Description	Version								
74HC30D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1								
74HCT30D			body width 3.9 mm									
74HC30PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1								
74HCT30PW			body width 4.4 mm									

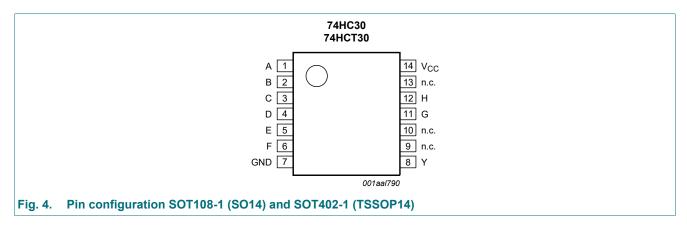


### 4. Functional diagram



### 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
A	1	data input
В	2	data input
С	3	data input
D	4	data input
Е	5	data input
F	6	data input
GND	7	ground (0 V)
Υ	8	data output
n.c.	9	not connected
n.c.	10	not connected
G	11	data input
Н	12	data input
n.c.	13	not connected
V <sub>CC</sub>	14	supply voltage

### 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input								Output
Α	В	С	D	E	F	G	Н	Y
L	Х	Х	Х	Х	Х	Х	Х	Н
X	L	Х	Х	Х	Х	Х	Х	Н
X	Х	L	Х	Х	Х	Х	Х	Н
X	Х	Х	L	Х	Х	Х	Х	Н
X	Х	Х	Х	L	Х	Х	Х	Н
X	Х	Х	Х	Х	L	Х	Х	Н
X	Х	Х	Х	Х	Х	L	Х	Н
X	Х	Х	Х	Х	Х	Х	L	Н
Н	Н	Н	Н	Н	Н	Н	Н	L

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V <sub>O</sub> < V <sub>CC</sub> + 0.5 V	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC30		74HCT30			Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

<sup>[2]</sup> For SOT108-1 (SO14) package: P<sub>tot</sub> derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P<sub>tot</sub> derates linearly with 7.3 mW/K above 81 °C.

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC30	1		'			1				
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_O = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

### 8-input NAND gate

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74НСТ3	0					<u>'</u>			-	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub> HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$									
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	2.0	-	20	-	40	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.4 \text{ V}; I_O = 0 \text{ A};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	60	216	-	275	-	294	μА
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

### 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

 $GND = 0 \ V; \ C_L = 50 \ pF;$  for test circuit see Fig. 6.

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
				Тур	Max	Min	Max	Min	Max	
74HC30									_	
t <sub>pd</sub>	propagation delay	A, B, C, D, E, F, G, H to Y; [1] see Fig. 5								
		V <sub>CC</sub> = 2.0 V	-	41	130	-	165	-	195	ns
		V <sub>CC</sub> = 4.5 V	-	15	26	-	33	-	39	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	12	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	12	22	-	28	-	33	ns
t <sub>t</sub>	transition	see <u>Fig. 5</u> [2]								
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
C <sub>PD</sub>	power dissipation capacitance	per package; [3] V <sub>I</sub> = GND to V <sub>CC</sub>	-	15	-	-	-	-	-	pF

### 8-input NAND gate

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
74HCT30										
t <sub>pd</sub>	propagation delay	A, B, C, D, E, F, G, H to Y; [1] see <u>Fig. 5</u>								
		V <sub>CC</sub> = 4.5 V	-	16	28	-	35	-	42	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	12	-	-	-	-	-	ns
t <sub>t</sub>	transition time	$V_{CC} = 4.5 \text{ V}; \text{ see } \frac{\text{Fig. 5}}{}$ [2]	-	7	15	-	19	-	22	ns
C <sub>PD</sub>	power dissipation capacitance	per package; [3] $V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}$	-	15	-	-	-	-	-	pF

- $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

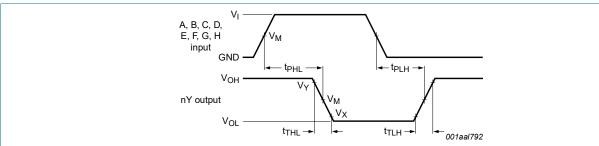
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

#### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

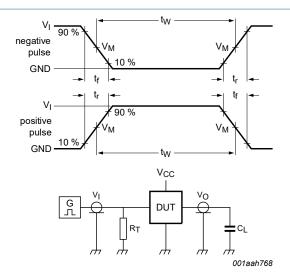
V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Input to output propagation delays and output transition times

**Table 8. Measurement points** 

Туре	Input	Output						
	$V_{M}$	V <sub>M</sub>	$V_X$	V <sub>Y</sub>				
74HC30	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>				
74HCT30	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>				

#### 8-input NAND gate



Test data is given in Table 9.

Definitions for test circuit:

 $R_{T}$  = termination resistance should be equal to the output impedance  $Z_{o}$  of the pulse generator.

 $C_L$  = load capacitance including jig and probe capacitance.

### Fig. 6. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load	Test
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC30	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT30	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

### 11. Package outline

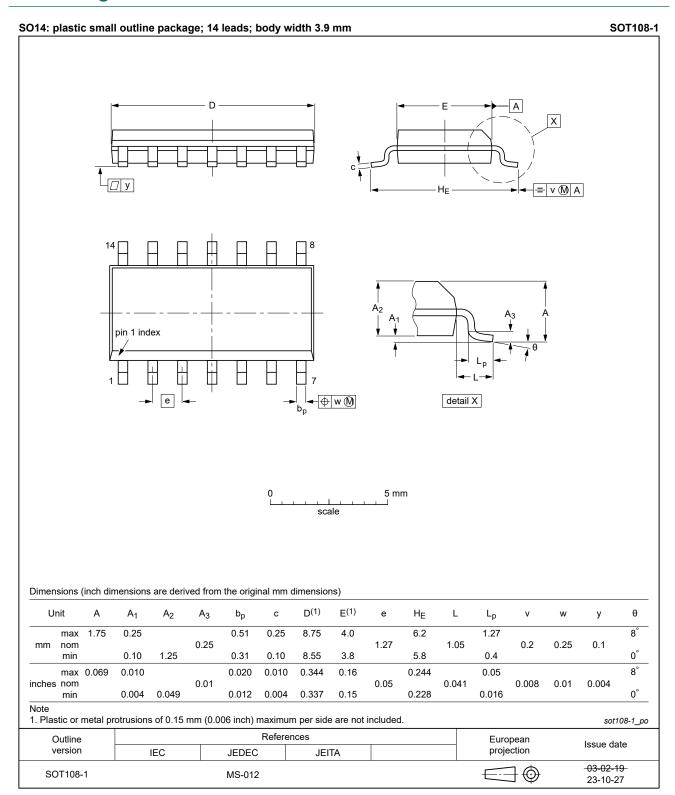


Fig. 7. Package outline SOT108-1 (SO14)

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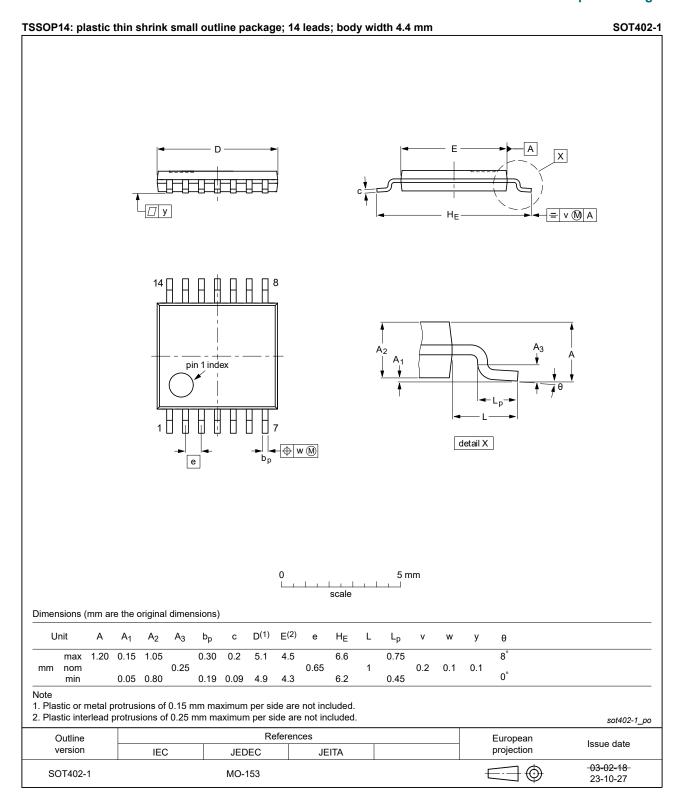


Fig. 8. Package outline SOT402-1 (TSSOP14)

#### 12. Abbreviations

Table 10. Abbreviations

able 10. Abbreviations	
Acronym	Description
CDM	Charged Device Model

74HC\_HCT30

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### 8-input NAND gate

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

# 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT30 v.10	20240313	Product data sheet	-	74HC_HCT30 v.9	
Modifications:		<ul> <li>Section 2: ESD specification updated according to the latest JEDEC standard.</li> <li>Fig. 7 and Fig. 8: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153.</li> </ul>			
74HC_HCT30 v.9	20210906	Product data sheet	-	74HC_HCT30 v.8	
Modifications:	Type number	Type number 74HCT30DB (SOT337-1 / SSOP14) removed.			
74HC_HCT30 v.8	20210209	Product data sheet	-	74HC_HCT30 v.7	
Modifications:	Nexperia.  Legal texts ha  Section 2 upd  Section 7: De	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 2 updated.</li> </ul>			
74HC_HCT30 v.7	20151202	Product data sheet	-	74HC_HCT30 v.6	
Modifications:	Type numbers	Type numbers 74HC30N and 74HCT30N (SOT27-1) removed.			
74HC_HCT30 v.6	20121227	Product data sheet	-	74HC_HCT30 v.5	
Modifications:	New general of	New general description.			
74HC_HCT30 v.5	20111213	Product data sheet	-	74HC_HCT30 v.4	
Modifications:	<ul> <li>Legal pages ι</li> </ul>	Legal pages updated.			
74HC_HCT30 v.4	20100504	Product data sheet	-	74HC_HCT30 v.3	
74HC_HCT30 v.3	20100420	Product data sheet	-	74HC_HCT30 v.2	
74HC_HCT30 v.2	19970829	Product specification	-	-	

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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